



ELENA AIMS TO ESTABLISH

- the first European LNOI-based open-access PIC foundry through the creation of a Process Design Kit (PDK) library of standard Building Blocks (BBs) for the LNOI PIC platform to enable a large variety of PIC designs, accessible through monolithic integration and combination of BBs;
- a fully European supply chain for the LNOI PIC foundry from wafer manufacturing, PIC design and simulations to characterisation and packaging.

OBJECTIVE #01

Develop and mature key passive and active BBs for the LNOI PIC platform as well as a reliable and reproducible BB fabrication process.

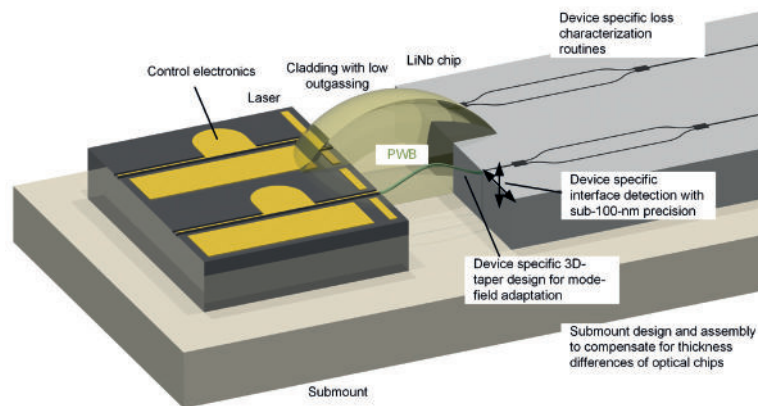
OBJECTIVE #02

Expand the foundry capabilities by integrating indium phosphide (InP) BBs (for light emission and detection) with a flexible and automatic assembly process.

OBJECTIVE #03

Develop a commercialization strategy including the key aspects of a supply chain:

- establishing the processes to produce 150 mm diameter optical-grade LNOI wafers on an industrial scale;
- developing a reliable and flexible method for packaging LNOI chips and interfacing them with other PIC platforms such as InP using 3D-printed Photonic Wirebonds (PWB) for low-cost hybrid integration.



OBJECTIVE #04

Produce four PIC prototypes for the end-user partners in the project consortium to demonstrate the monolithic integration of the newly developed BBs.

OBJECTIVE #05

Create an end-user group and a strong network of stakeholders to promote ELENA's LNOI-integrated photonics.

ELENA: TECHNOLOGY DRIVER FOR NEXT-DECADE PICS



HIGH BANDWIDTH

- Exponential expansion of the internet (beyond 400 Gbit/s)
- Next-generation communication technologies (5G/6G)
- New bandwidth-demanding applications (AR, VR, IoT, etc.)
- Cloud computing



LARGE-SCALE INTEGRATION

- Low-loss and compact footprint
- Heterogeneous integration
- Photonic-electronics co-integration
- Programmable PICs



WIDE WAVELENGTH RANGE OPERATION

- Availability of new bands / expansion of optical data link (L-band, S-band, etc.)
- Demand for PICs in new wavelength ranges such as visible and near infrared:
 - quantum computing
 - biosensing
 - Raman spectroscopy



LOW POWER CONSUMPTION

- Fewer joules per bit
- Cost-effective integrated systems
- Versatile packaging
- Low thermal parasitic effects
- Low-loss waveguide



NEW FUNCTIONALITIES

- On-chip nonlinear wavelength conversion
- Optical isolators and circulators
- Acousto-optical modulators
- Narrow linewidth, fast tunable lasers
- Ultra-fast photodetectors
- Entangled/single-photon sources

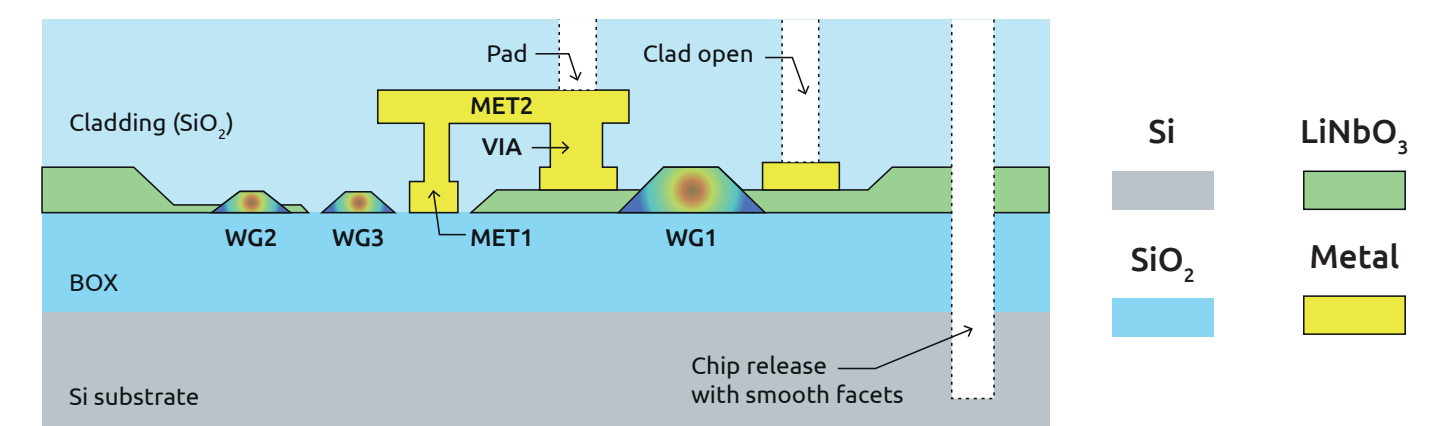
LNOI – A VERSATILE PIC PLATFORM FOR THE FUTURE

- Intrinsic EO coefficient**
 - Fast (> 100 GHz) and low V_{π} (< 1 V) modulators
 - Addressing the need for a wider bandwidth
 - CMOS-level voltage operation
 - Ultra-low insertion loss modulators
- Integration and scalability**
 - Low-loss waveguides (< 0.1dB/cm)
 - Small bending radii (~30µm)
 - Compact circuit footprint
 - Low-power building blocks
 - Programmable photonics
 - High-port-count switches

- Wide bandgap**
 - LiNbO₃ bandgap = 4.9 eV
 - High optical power handling
 - Low optical loss
 - No parasitic two-photon absorption
- Large 2nd and 3rd order optical nonlinearities**
 - Non-linear photonics and metrology
 - Wavelength conversion, 2nd harmonic generation, DFG, and SFG
 - Optical frequency combs and supercontinuum generation
 - Entangled photon pair generation

- Piezoelectric effect**
 - Acousto-optical modulators (AOM)
 - Optical MEMS integration
 - Gyros and pressure sensors
- Wide transparency window**
 - LiNbO₃ is transparent for 350 nm to 5.5 µm wavelength span
 - Availability of new bands / expansion of optical data link
 - Electro-optical light control below µm wavelength (the range in which Si or InP are not transparent)

CSEM'S LNOI PIC PLATFORM



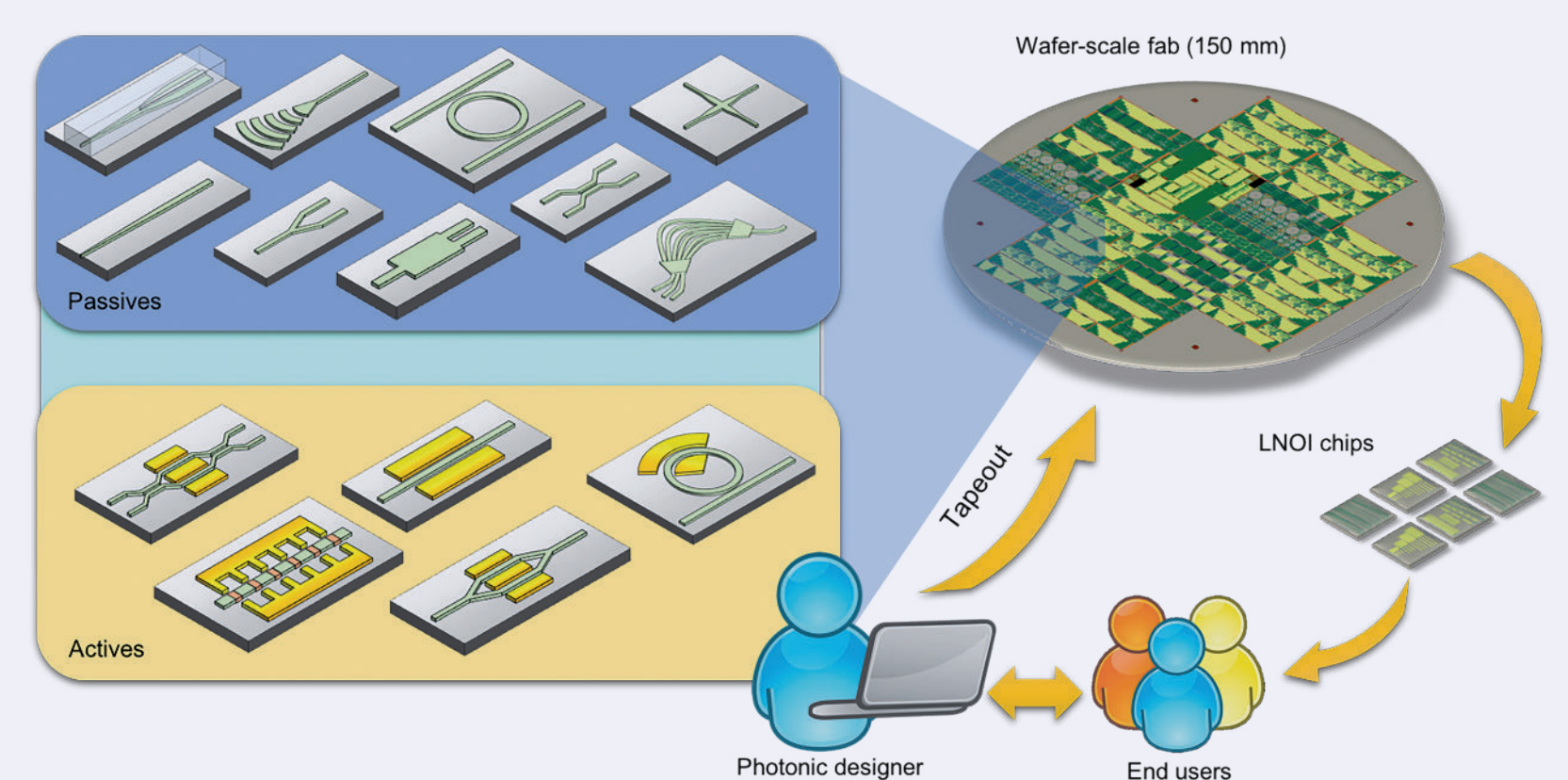
Property	Value
Wafer cut	x
Refractive index (ordinary)	2.21 (@ 1550 nm)
Refractive index (ex-ordinary)	2.13 (@ 1550 nm)
Bandgap	4.9eV
Transparency window	350nm - 5.5 µm
EO coefficient	$r_{33} = 31 \text{ pm/V}$
$X^{(2)}$ nonlinearity	$3 \times 10^{-11} \text{ m/V}$
$X^{(2)}$ nonlinearity	$1.6 \times 10^{-21} \text{ m}^2 \text{ V}^{-2}$
Piezoelectric coefficient	$d_{33} = 6.0 \times 10^{-12} \text{ C/N}$

APPLICATIONS

Thanks to the unique properties of lithium niobate, an LNOI PIC platform could serve many applications ranging from **telecom** (e.g. supporting ultra-high-speed transceivers beyond 100 GHz), LIDAR (e.g. ideal for FMCW LIDAR engines and OPAs) and **space applications** (compatibilities with harsh environments and wide transparency range), to **nonlinear photonics** (e.g. new functionalities such as on-chip wavelength conversion), **optical signal processing** and **optical computing** (e.g. neuromorphic computing), **sensing & spectroscopy** (e.g. on-chip bio sensing at visible and NIR and mid-IR gas sensing), as well as **quantum computing** (e.g. continuous variables, photonics drivers of atomic systems and QKD).

- Signal processing
- LIDAR
- Telecom
- Sensing & spectroscopy
- Space
- Nonlinear optics
- Quantum computing

ELENA'S ENVISIONED LIBRARY OF STANDARDISED BUILDING BLOCKS: TOWARDS THE FIRST LNOI PHOTONICS PROCESS DESIGN KIT (PDK)



CONSORTIUM



IN A NUTSHELL

42 months, starting date: 1/1/2022,
10 partners, EC grant: 5 M€

COORDINATOR

Dr Hamed Sattari, CSEM

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